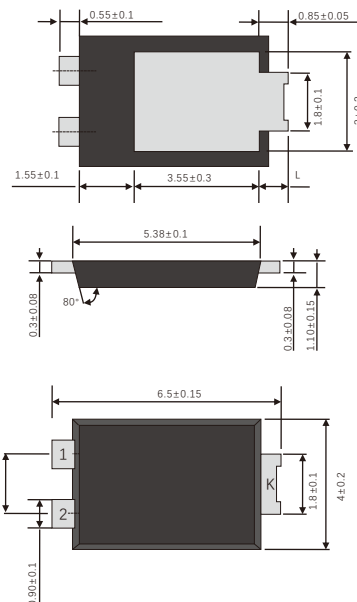


FEATURES

- Plastic package has Underwriters Laboratory Flammability Classification 94V-0
 - Metal silicon junction ,majority carrier conduction
 - Guard ring for overvoltage protection
 - Low power loss ,high efficiency
 - High current capability ,low forward voltage drop
 - High surge capability
 - Very low profile-typical height of 1.1mm
 - Ideal for automated placement
 - High temperature soldering guaranteed:260°C/10 seconds at terminals
- Component in accordance to RoHS 2015/863/EU



TO-277

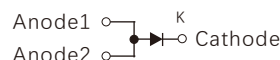


MECHANICAL DATA

- Case: TO-277 molded plastic body
- Terminals: Plated axial leads, solderable per MIL-STD-750,method 2026
- Mounting Position: Any
- Weight: 0.092 grams(approx)

TYPICAL APPLICATIONS

For use in low voltage ,high frequency inverters ,DC/DC converters, free wheeling ,and polarity protection applications



Dimensions in inches and (millimeters)

MAXIMUM RATINGS

(Ratings at 25°C ambient temperature unless otherwise specified)

Parameter	Symbol	Value	Unit
Maximum repetitive peak reverse voltage	V_{RRM}	60	V
Maximum average forward rectified current	$I_{F(AV)}$	15.0	A
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC method at rated TL)	I_{FSM}	200	A
Operating junction temperature range	T_J	-55 to+150	°C
Storage temperature range	T_{stg}	-55 to+150	°C

ELECTRICAL CHARACTERISTICS (T_A=25°C Unless otherwise noted)

Parameter	Test Conditions		Symbol	TYP.	MAX.	Unit
Instantaneous forward voltage	I _F =15.0A	T _A =25°C	V _F ¹⁾	0.48	0.55	V
		T _A =100°C		0.43	-	
		T _A =125°C		0.41	-	
	I _F =5.0A	T _A =25°C		0.41	-	
		T _A =100°C		0.33	-	
		T _A =125°C		0.30	-	
Reverse current	V _R =60V	T _A =25°C	I _R ²⁾	-	150	μA
		T _A =100°C		-	10	mA
		T _A =125°C		-	30	
Typical junction capacitance	4V,1MHz		C _J	2000		pF

Notes: 1.Pulse test: 300 μs pulse width,1% duty cycle

2.Pulse test: pulse width ≤40ms

THERMAL CHARACTERISTICS

Parameter	Symbol	TO-277	Unit
Typical thermal resistance ³⁾	R _{θJA}	60.0	°C/W
	R _{θJL}	3.0	

3 Units mounted on recommended PCB 1 oz. Pad layout

AVAILABLE PACK INFORMATION

Product code	Pack	Reel Size (mm)	Quantity (pcs/reel)	Box Size L×W×H (mm)	Quantity (reel/box)	Carton Size L×W×H (mm)	Quantity (box/carton)
SP15U60SL-TO-277	T/R	φ 330	5000	338×338×40	2	365×365×360	7

RATINGS AND CHARACTERISTIC OF SP15U60SL

FIG.1-FORWARD CURRENT DERATING CURVE

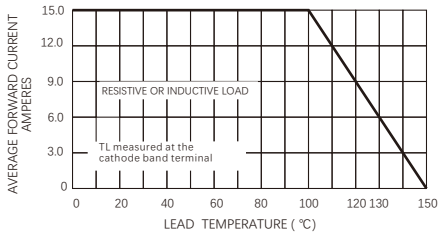


FIG.2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

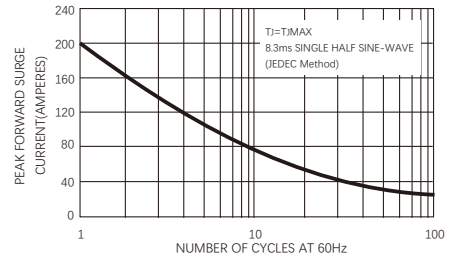


FIG.3-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

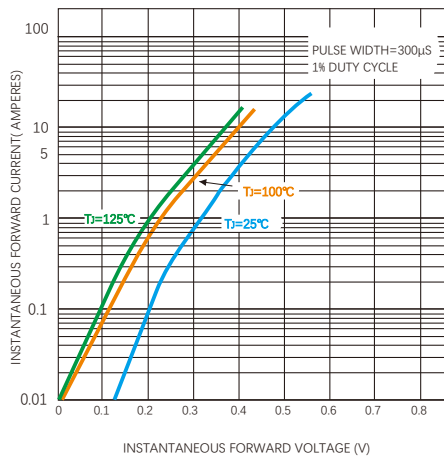


FIG.4-TYPICAL REVERSE CHARACTERISTICS

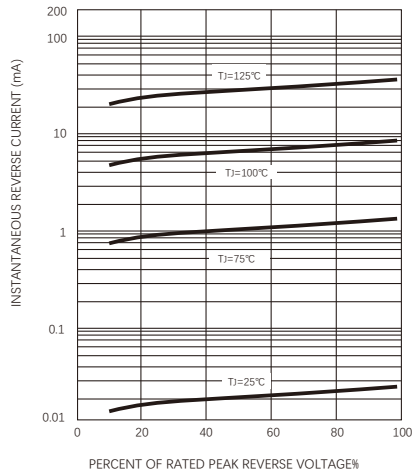
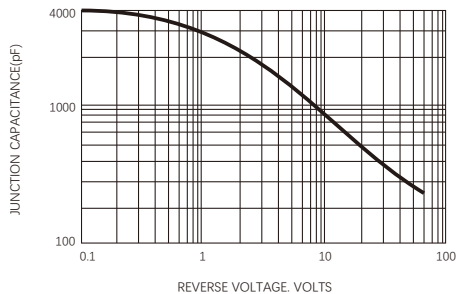


FIG.5-TYPICAL JUNCTION CAPACITANCE



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